DESCRIPTION

The GS1A~GS1M are available in SMA Package.

ORDERING INFORMATION

Package Type	Part Number						
SMA	GS1A						
	GS1B						
	GS1D						
	GS1G						
	GS1J						
	GS1K						
	GS1M						
Note	SPQ: 2,000pcs/Reel						
AiT provides all RoHS Compliant Products							

FEATURES

- The plastic package carries Underwriters
 Laboratory Flammability Classification 94V-0
- For surface mounted applications
- Low reverse leakage
- Built-in strain relief, ideal for automated placement
- High forward surge current capability
- High temperature soldering guaranteed:
- 250°C /10 seconds at terminals
- Glass passivated chip junction
- Available in SMA Package

MECHANICAL DATA

Case: JEDEC DO-214AC molded plastic body over

passivated chip

Terminals: Solder plated, solderable per

MIL-STD-750, Method 2026

Polarity: Color band denotes cathode end

Mounting Position: Any

Weight: 0.002ounce, 0.07grams

REV1.0 - DEC 2014 RELEASED - -1



ELECTRICAL CHARACTERISTICS

Ratings at 25° C ambient temperature unless otherwise specified. Single phase half-wave 60Hz, resistive or inductive load, for capacitive load current derate by 20%

Parameter	Symbol	GS1A	GS1B	GS1D	GS1G	GS1J	GS1K	GS1M	Unit
Maximum repetitive peak reverse			100	000	400	000	000	1000	
voltage	V_{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS voltage	V _{RMS}	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	V_{DC}	50	100	200	400	600	800	1000	V
Maximum average forward rectified current at T _L =110°C	I _(AV)	1.0							Α
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I _{FSM}	30.0							А
Maximum instantaneous forward voltage at 1.0A	VF	1.1							V
Maximum DC reverse current T _A = 25°C	,	5.0 50.0							μΑ
at rated DC blocking voltage T _A = 100°C	I _R								
Typical junction capacitance NOTE1	Сл	15.0							pF
Typical thermal resistance NOTE2	RθJA	75.0							°C/W
Operating junction and storage temperature range	T _J , T _{STG}	-50 ~ +150							°C

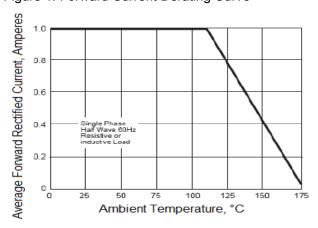
NOTE1: Measured at 1MHz and applied reverse voltage of 4.0V D.C. NOTE2: P.C.B. mounted with 0.2x0.2"(5.0x5.0mm) copper pad areas

REV1.0 - DEC 2014 RELEASED - -2-

TYPICAL CHARACTERISTICS

$T_A = 25$ °C unless otherwise specified.

Figure 1. Forward Current Derating Curve



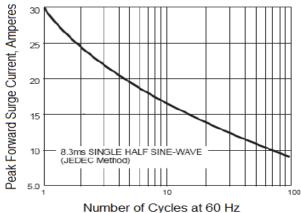


Figure 2. Maximum Non-Repetitive Peak Forward

Figure 3. Typical Instantaneous Forward Characteristics

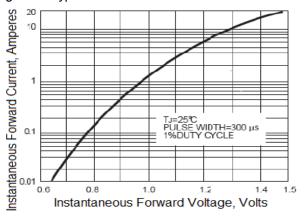


Figure 4. Typical Reverse Characteristics

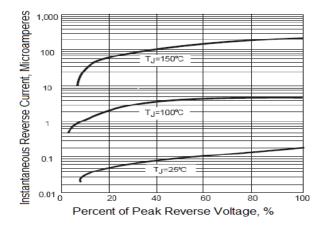


Figure 5. Typical Junction Capacitance

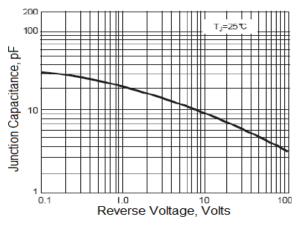
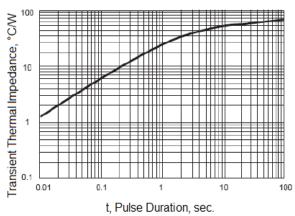


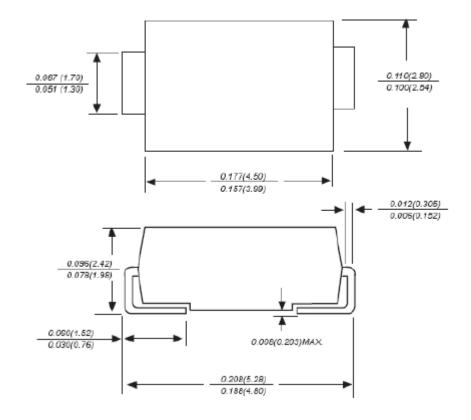
Figure 6. Typical Transient Thermal Impedance



REV1.0 - DEC 2014 RELEASED -- 3 -

PACKAGE INFORMATION

Dimension in SMA Package (Unit: mm)



REV1.0 - DEC 2014 RELEASED - - 4 -



IMPORTANT NOTICE

AiT Components (AiT) reserves the right to make changes to any its product, specifications, to discontinue any integrated circuit product or service without notice, and advises its customers to obtain the latest version of relevant information to verify, before placing orders, that the information being relied on is current.

AiT Components' integrated circuit products are not designed, intended, authorized, or warranted to be suitable for use in life support applications, devices or systems or other critical applications. Use of AiT products in such applications is understood to be fully at the risk of the customer. As used herein may involve potential risks of death, personal injury, or servere property, or environmental damage. In order to minimize risks associated with the customer's applications, the customer should provide adequate design and operating safeguards.

AiT Components assumes to no liability to customer product design or application support. AiT warrants the performance of its products of the specifications applicable at the time of sale.

REV1.0 - DEC 2014 RELEASED - - 5 -